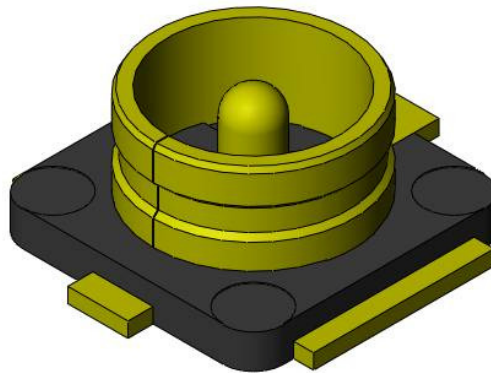
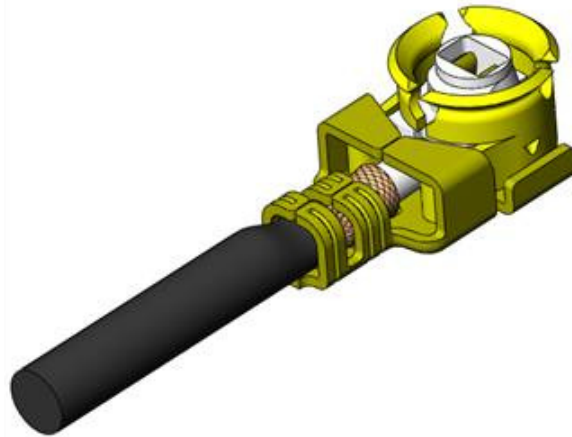




Project Number: Design Qualification Test Report	Tracking Code: 312143_Report_Rev_1
Requested by: Tori Meek	Date: 03/4/2014
Part #: MH113-MH1RP-MH1RP-0305/RSP-122811-01	
Part description: MH113/RSP	Tech: Kason He
Test Start: 02/25/2014	Test Completed: 02/26/2014



DESIGN QUALIFICATION TEST REPORT

MH113/RSP
MH113-MH1RP-MH1RP-0305/RSP-122811-01

Tracking Code: 312143_Report_Rev_1	Part #: MH113-MH1RP-MH1RP-0305/RSP-122811-01
Part description: MH113/RSP	

REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
03/04/2014	1	Initial Issue	KH

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

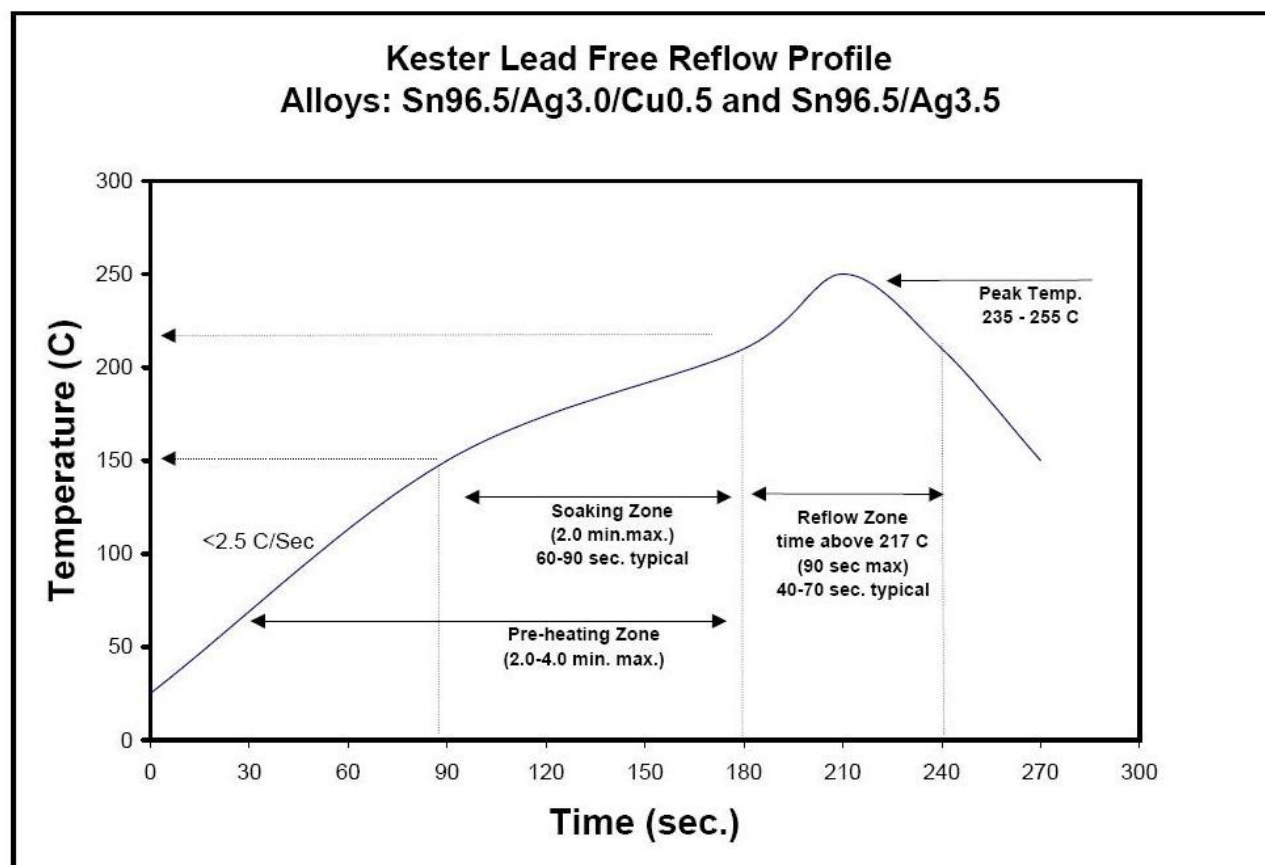
To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 4) The automated procedure is used with aqueous compatible soldering materials.
- 5) Any additional preparation will be noted in the individual test sequences.
- 6) Solder Information: Lead Free
- 7) Re-Flow Time/Temp: See accompanying profile.
- 8) Samtec Test PCBs used: PCB-106148-TST

TYPICAL OVEN PROFILE (Soldering Parts to Test Boards)

FLOWCHARTS

Current Carrying Capacity

Group 1

MH113-MH1RP-MH1RP-0305

RSP-122811-01

1 Pins Powered

Signal

*Note: Monitor contact interface, cable center conductor, and crimp**Note: Full transmission line, test signal contact CCC only.*

Step	Description
------	-------------

- | | |
|----|--|
| 1. | CCC (1)
Number of Positions = 1
Rows = 1 |
|----|--|

Group 2

MH113-MH1RP-MH1RP-0305

RSP-122811-01

1 Pins Powered

Cable-31 AWG

*Note: Power center conductor only, monitor center conductor in cable.**Note:**Note: Cable only, CCA-113. No connectors.*

Step	Description
------	-------------

- | | |
|----|--|
| 1. | CCC (1)
Rows = 1
Number of Positions = 1 |
|----|--|

(1) CCC = EIA-364-70

Method 2, Temperature Rise Versus Current Curve

(TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C

(GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) EIA-364-70, *Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets*.
- 2) When current passes through a contact, the temperature of the contact increases as a result of I^2R (resistive) heating.
- 3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
- 4) The size of the temperature probe can affect the measured temperature.
- 5) Copper traces on PC boards will contribute to temperature rise:
 - a. Self heating (resistive)
 - b. Reduction in heat sink capacity affecting the heated contacts
- 6) A de-rating curve, usually 20%, is calculated.
- 7) Calculated de-rated currents at three temperature points are reported:
 - a. Ambient
 - b. 85° C
 - c. 95° C
 - d. 115° C
- 8) Typically, neighboring contacts (in close proximity to maximize heat build up) are energized.
- 9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
- 10) A computer program, *TR 803.exe*, ensures accurate stability for data acquisition.
- 11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
- 12) Hook-up wire length is longer than the minimum specified in the referencing standard.

Tracking Code: 312143_Report_Rev_1	Part #: MH113-MH1RP-MH1RP-0305/RSP-122811-01
Part description: MH113/RSP	

RESULTS

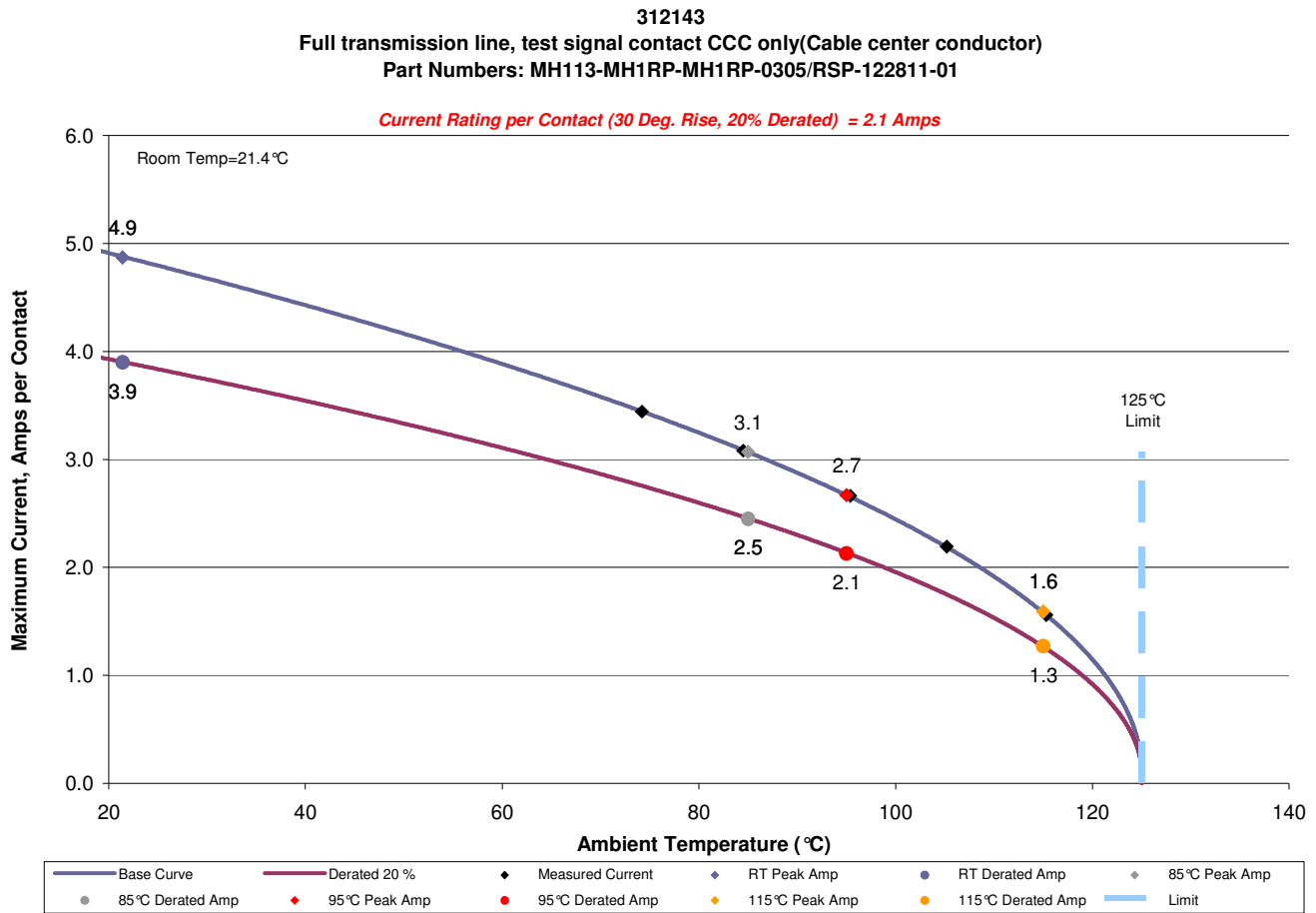
Temperature Rise, CCC at a 20% de-rating

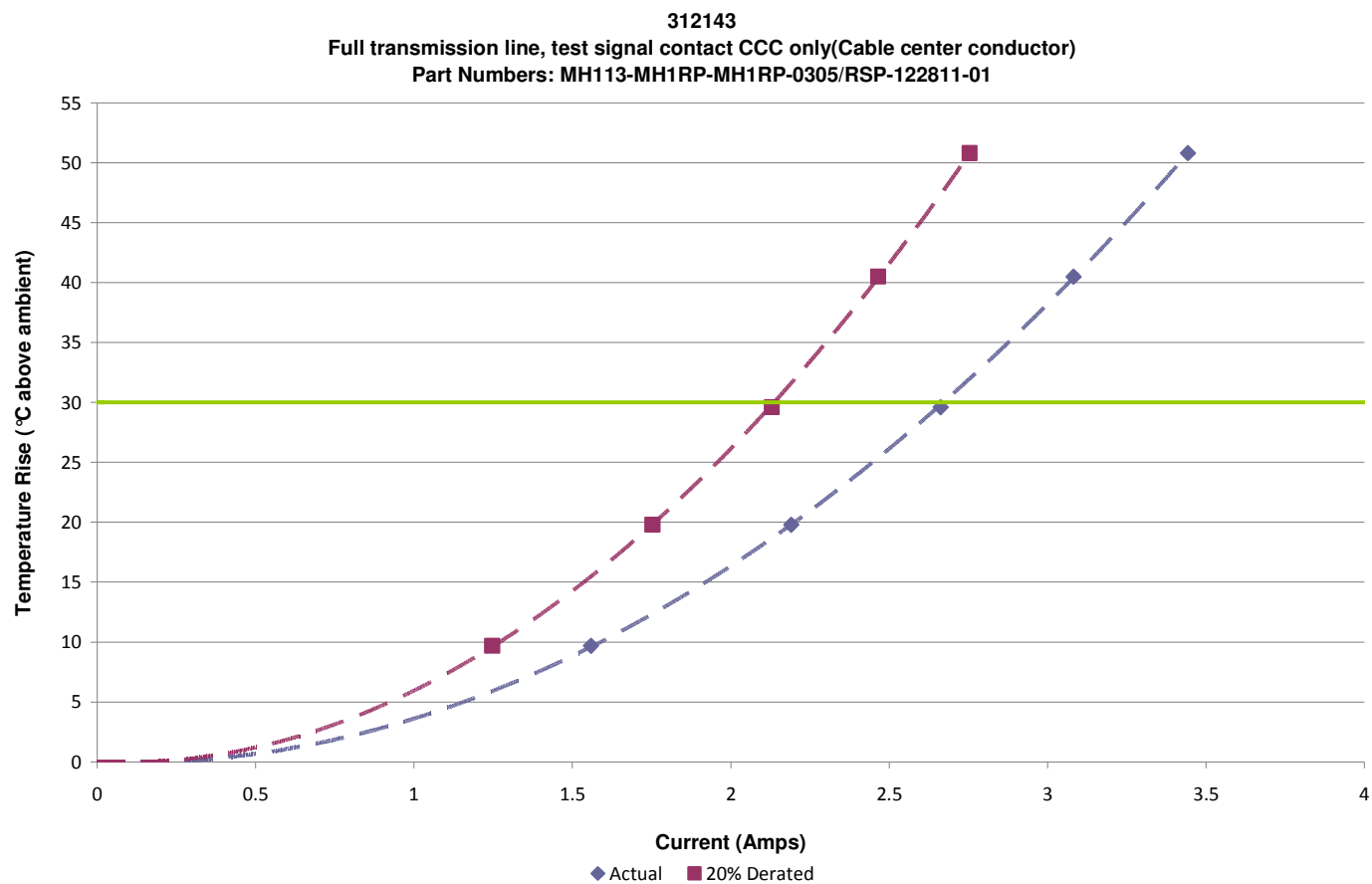
- CCC for a 30°C Temperature Rise-----2.1 A full transmission line, monitor cable center conductor
- CCC for a 30°C Temperature Rise-----2.3 A power center conductor only(no connectors), monitor center Conductor in cable

DATA SUMMARIES

TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
- 2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
- 3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
- 4) Adjacent contacts were powered:
 - a. Full transmission line, test signal contact CCC only(cable center conductor)



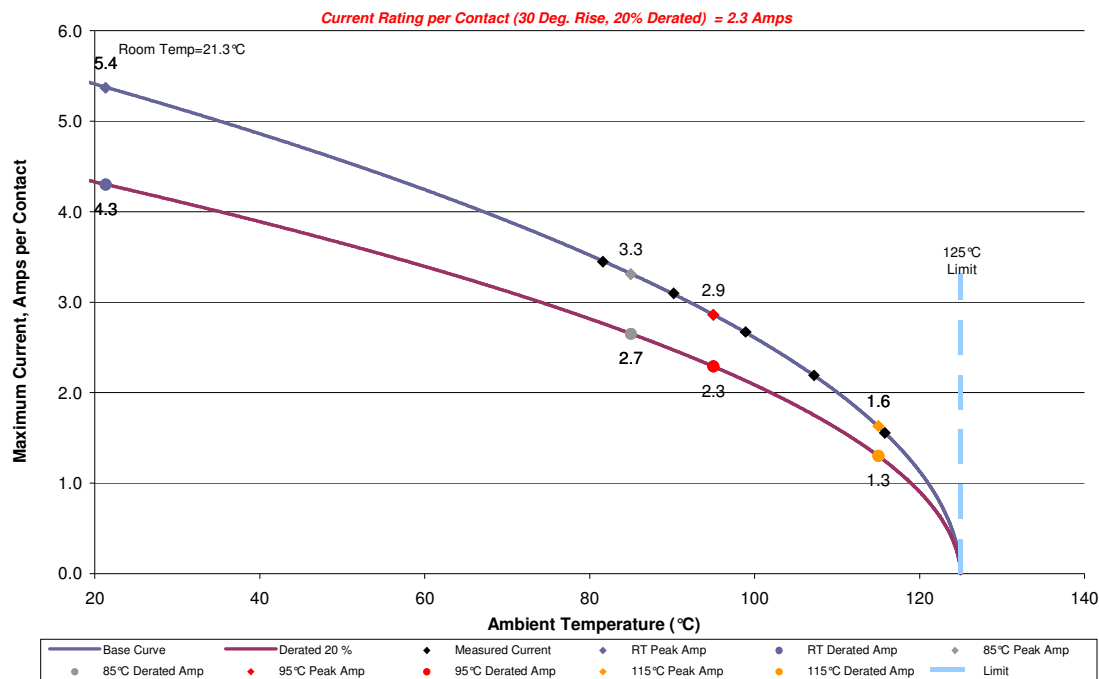


DATA SUMMARIES Continued**b. Power center conductor only(no connectors), monitor center conductor in cable**

312143

Power center conductor only, monitor center conductor in cable(Cable center conductor)

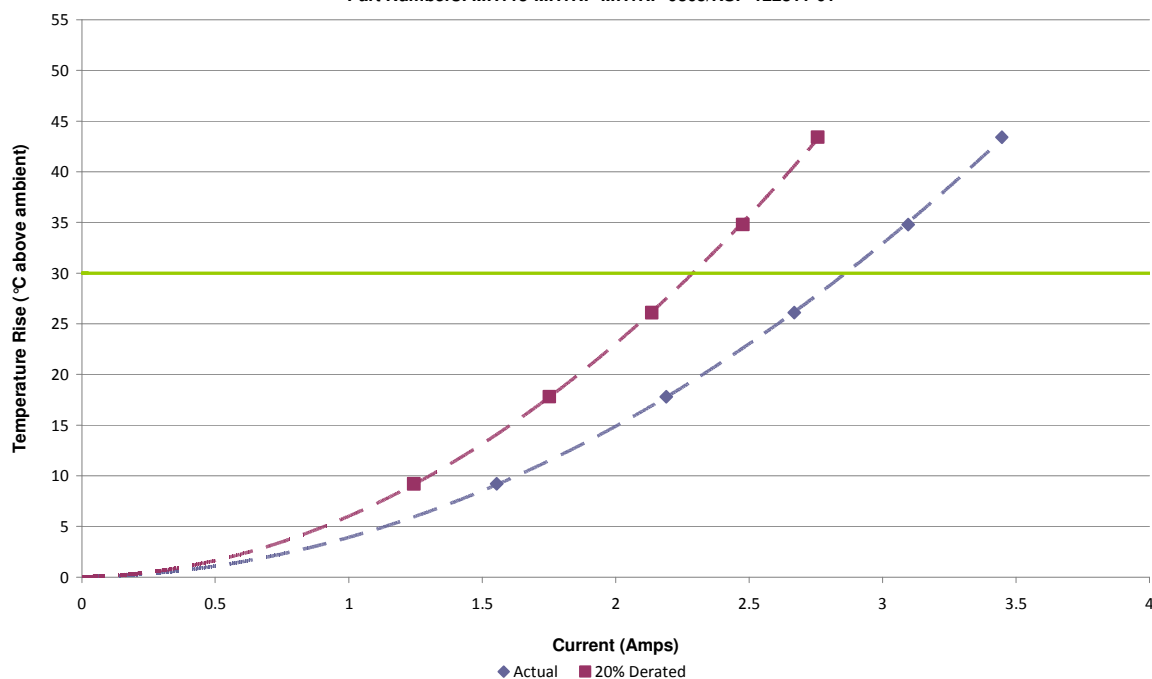
Part Numbers: MH113-MH1RP-MH1RP-0305/RSP-122811-01



312143

Full transmission line, test signal contact CCC only(Cable center conductor)

Part Numbers: MH113-MH1RP-MH1RP-0305/RSP-122811-01



EQUIPMENT AND CALIBRATION SCHEDULES**Equipment #:** HZ-PS-01**Description:** 120 Amp Power Supply**Manufacturer:** Agilent**Model:** 6031**Serial #:** MY41000982**Accuracy:** See Manual

... Last Cal: 06/29/2013, Next Cal: 06/28/2014

Equipment #: HZ-MO-01**Description:** Multimeter /Data Acquisition System**Manufacturer:** Keithley**Model:** 2700**Serial #:** 1199807**Accuracy:** See Manual

... Last Cal: 06/29/2013, Next Cal: 06/28/2014